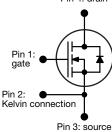
SiHH240N60E

Vishay Siliconix



E Series Power MOSFET





N-Channel MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.208			
Q _g max. (nC)	23				
Q _{gs} (nC)	4				
Q _{gd} (nC)	6				
Configuration	Single				

Pin 4: drain

- FEATURES
- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and halogen-free	SiHH240N60E-T1-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	V	
Gate-source voltage			V _{GS}	± 30	v	
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	I.,	12		
	VGS AL TO V	T _C = 100 °C	ID	7	А	
Pulsed drain current ^a			I _{DM}	30		
Linear derating factor				0.63	W/°C	
Single pulse avalanche energy b			E _{AS}	81	mJ	
Maximum power dissipation			PD	89	W	
Operating junction and storage temperature ra	ange		T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	rain-source voltage slope $T_J = 125 \text{ °C}$		dv/dt	100	V/ns	
Reverse diode dv/dt ^c			uv/dl	28		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 2.4 A
- c. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

1



COMPLIANT

HALOGEN

FREE GREEN

(5-2008)



THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.	MA	Х.	UNIT			
Maximum junction-to-ambient	R _{thJA}	42	55	55		20.00		
Maximum junction-to-case (drain)	R _{thJC}	1.0	1.0 1.4			°C/W		
			·					
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static								
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	600	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.63	-	V/°C	
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	3.0	-	5.0	V	
Gate-source leakage			$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Gale-source leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA	
Zara anto voltago drain ourrent	la a a	V _{DS} =	V _{DS} = 600 V, V _{GS} = 0 V		-	1	μA	
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$		-	-	10		
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	V _{GS} = 10 V I _D = 5.5 A		0.208	0.240	Ω	
Forward transconductance ^a	9 _{fs}	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}$		-	4	-	S	
Dynamic								
Input capacitance	C _{iss}		V _{GS} = 0 V,		783	-	-	
Output capacitance	C _{oss}	$V_{DS} = 100 V,$ f = 1 MHz		-	50	-		
Reverse transfer capacitance	C _{rss}			-	5	-		
Effective output capacitance, energy related ^a	C _{o(er)}				32	-	pF	
Effective output capacitance, time related ^b	C _{o(tr)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	187	-		
Total gate charge	Qg			-	15	23		
Gate-source charge	Q _{gs}	V _{GS} = 10 V I _D = 5.5 A, V _{DS} = 480 V		v -	4	-	nC	
Gate-drain charge	Q _{gd}			-	6	-		
Turn-on delay time	t _{d(on)}	V_{DD} = 480 V, I _D = 5.5 A, V _{GS} = 10 V, R _g = 9.1 Ω		-	15	30		
Rise time	t _r			-	14	28	ns	
Turn-off delay time	t _{d(off)}			-	26	52		
Fall time	t _f	1	-	14	28			

f = 1 MHz, open drain

 T_J = 25 °C, I_S = 5.5 A, V_{GS} = 0 V

 $T_J=25~^\circ C,~I_F=I_S=5.5~A,$

 $di/dt = 100 \text{ A}/\mu \text{s}, \text{ V}_{\text{R}} = 25 \text{ V}$

MOSFET symbol

integral reverse p - n junction diode

showing the

Notes

Gate input resistance

Diode forward voltage

Reverse recovery time

Reverse recovery charge

Reverse recovery current

Drain-Source Body Diode Characteristics

Continuous source-drain diode current

Pulsed diode forward current

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

Rg

Is

I_{SM}

V_{SD}

t_{rr}

Q_{rr}

I_{RRM}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

2

1.5

-

-209

2.1

18

0.8

-

-

-

-

-

3.0

12

30

1.2

418

4.2

_

Ω

А

٧

ns

μC

А



SiHH240N60E

Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

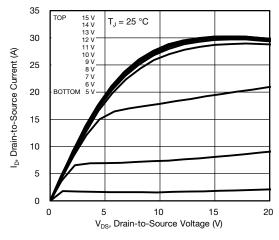


Fig. 1 - Typical Output Characteristics

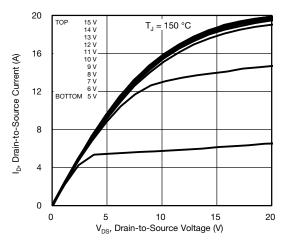


Fig. 2 - Typical Output Characteristics

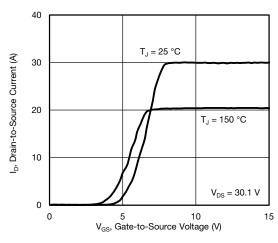


Fig. 3 - Typical Transfer Characteristics

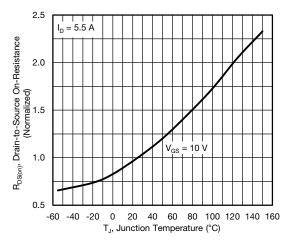


Fig. 4 - Normalized On-Resistance vs. Temperature

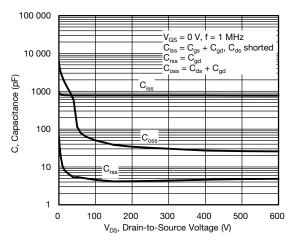


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

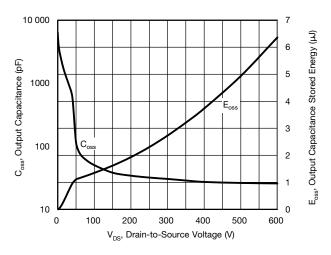


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

S23-0653-Rev. D, 21-Aug-2023

3 questions contact: hym@vi Document Number: 92334

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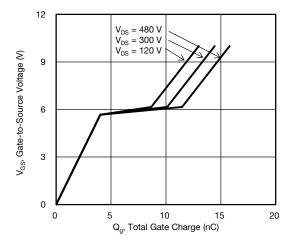


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

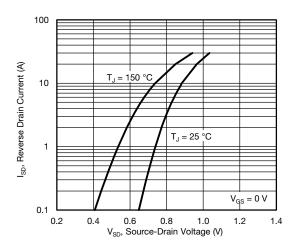


Fig. 8 - Typical Source-Drain Diode Forward Voltage

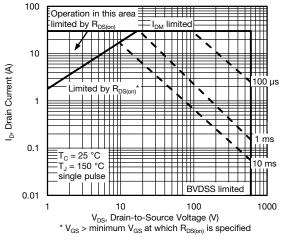


Fig. 9 - Maximum Safe Operating Area

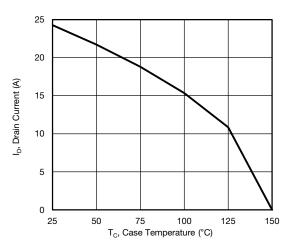


Fig. 10 - Maximum Drain Current vs. Case Temperature

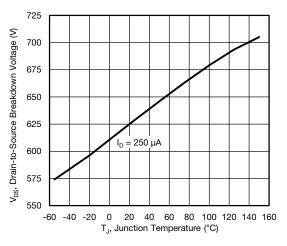


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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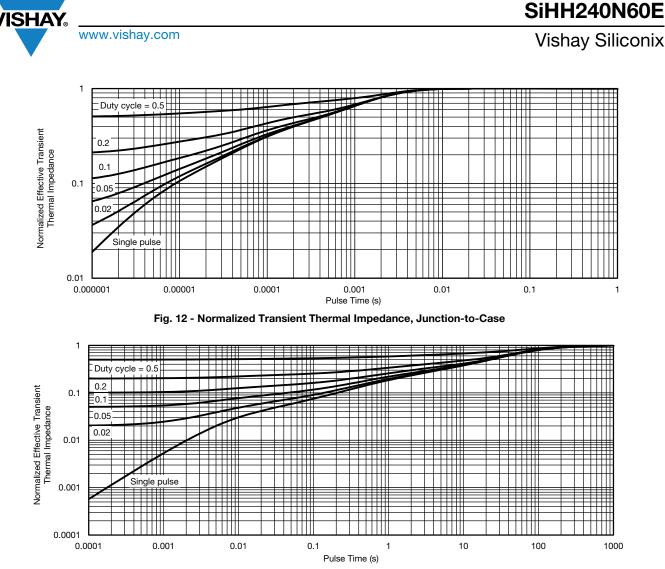


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

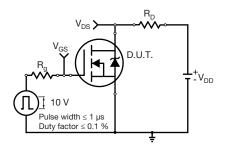


Fig. 14 - Switching Time Test Circuit

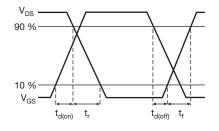


Fig. 15 - Switching Time Waveforms



SiHH240N60E

Vishay Siliconix

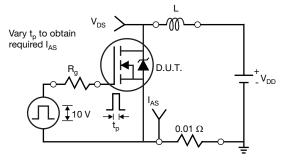


Fig. 16 - Unclamped Inductive Test Circuit

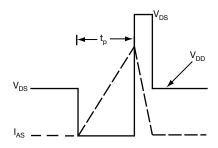


Fig. 17 - Unclamped Inductive Waveforms

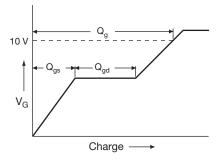


Fig. 18 - Basic Gate Charge Waveform

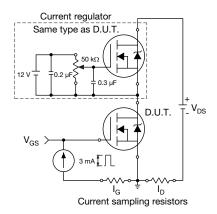


Fig. 19 - Gate Charge Test Circuit

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Peak Diode Recovery dv/dt Test Circuit

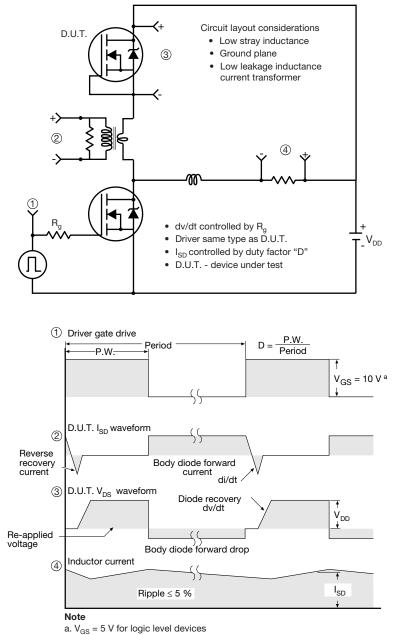
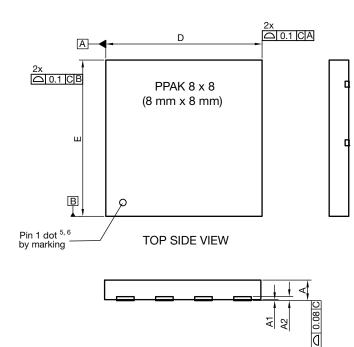


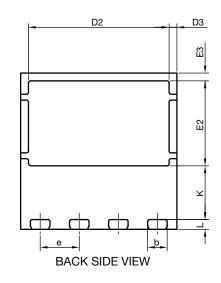
Fig. 20 - For N-Channel

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PowerPAK[®] 8 x 8 Case Outline





DIM		MILLIMETERS			INCHES	
DIM. MIN.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
А	0.95	1.00	1.05	0.037	0.039	0.041
A1	0.00	-	0.05	0.000	-	0.002
A2	020 ref.		0.008 ref.			
b	0.95	1.00	1.05	0.037	0.039	0.041
D	7.90	8.00	8.10	0.311	0.315	0.319
D2	7.10	7.20	7.30	0.280	0.283	0.287
D3	0.40 BSC		0.016 BSC			
е	2.00 BSC		0.079 BSC			
E	7.90	8.00	8.10	0.311	0.315	0.319
E2	4.30	4.35	4.40	0.169	0.171	0.173
E3	0.40 BSC		0.016 BSC			
К	2.75 BSC		0.108 BSC			
L	0.45	0.50	0.55	0.018	0.020	0.022
N ⁽³⁾	8 8					

Notes

⁽¹⁾ Use millimeters as the primary measurement

⁽²⁾ Dimensioning and tolerances conform to ASME Y14.5 M - 1994

⁽³⁾ N is the number of terminals

⁽⁴⁾ The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body

⁽⁵⁾ Exact shape and size of this feature is optional

ECN: E20-0518-Rev. B, 28-Sep-2020 DWG: 6041

Revision: 28-Sep-2020

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Recommended Minimum PADs for PowerPAK[®] 8 mm x 8 mm



Dimensions in millimeters

Document Number: 68441



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